

Form 1449 (Modified) Information Disclosure Statement By Applicant (Use Several Sheets if Necessary)	Atty Docket No. NSC1P205D2	Application No.: Not yet assigned 10/652805
	Applicant: Nguyen et al. Filing Date August 29, 2003	Group 2811 Not yet assigned

U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
DHL	A	5,011,246	04/30/91	Corradetti et al.			
	B	6,305,848	10/23/01	Gregory			
	C	6,201,704	03/13/01	Poplawski et al.			
	D	6,318,909	11/20/01	Giboney et al.			
	E	5,487,124	01/23/96	Bowen et al.			
	F	5,949,135	09/07/99	Washida et al.			
	G	6,043,430	03/28/00	Chun			
	H	6,236,109	05/22/01	Hsuan et al.			
	I	5,139,969	08/18/92	Mori			
	J	6,258,630	07/10/01	Kawahara			
	K	6,316,837	11/13/01	Song			
	L	2001/0013645	08/16/01	King et al.			
	M	6,316,838	11/13/01	Ozawa et al.			
	N	5,726,079	03/10/98	Johnson			

Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
							Yes	No
DHL	O	JP 08-125066	05/17/96	Japan				
DK	P	60-202956	10/14/85	Japan				

Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
DHL	Q	S. Savastiouk, PH.D., et al. "3-D stacked wafer-level packaging", March 2000, <i>Advanced Packaging</i> , pgs. 28-34.
DHL	R	National Semiconductor, "Packaging Databook", 1993 <i>National Semiconductor</i> , pgs. v-xi to 1-3 to 1-4, 3-1 to 3-20, 3-30 to 3-31, 3-62 to 3-69. Please note: The year of publication is sufficiently earlier than the effective U.S. filing date so that the particular month of publication is not in issue.
Examiner Kang, Donghee		Date Considered 07-07-04

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Form 1449 (Modified) Information Disclosure Statement By Applicant (Use Several Sheets if Necessary)	Atty Docket No. NSC1P205D2	Application No.: Not yet assigned 10/652 865
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U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
DHL	S	5,352,926	10/04/94	Andrews			
	T	5,579,208	11/26/96	Honda <i>et al.</i>			
	U	5,723,369	03/03/98	Barber			
	V	5,019,673	05/28/91	Juskey <i>et al.</i>			
	W	5,608,262	03/04/97	Degani <i>et al.</i>			
	X	5,790,384	08/04/98	Ahmad <i>et al.</i>			
	Y	5,798,567	08/25/98	Kelly <i>et al.</i>			
	Z	2002/0100974	08-2002	Uchiyama			
	AA	2001/0019173	09-2001	Taguchi <i>et al.</i>			
	AB	2001/0048151	12-2001	Chun			
	AC	2002/0047216	04-2002	Jiang <i>et al.</i>			
	AD	2002/0089067	07-2002	Crane <i>et al.</i>			

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Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
							Yes	No

Other Documents

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Examiner	Kang, Donghee	Date Considered	07-07-04
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